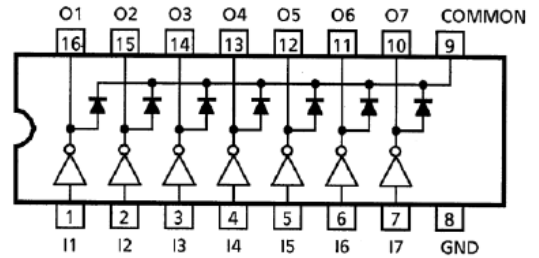# LTspice Model
ARRAY
TOSHIBA
TBD62003AFWG

(top view)

Model Information

Model An original macro model
Call Name MDC_TBD62003AFWG_LT
Pin Assign 1:I1 2:I2 3:I3 4:I4 5:I5 6:I6 7:I7 8:GND 9:COM 10:O7 11:O6 12:O5 13:O4 14:O3 15:O2 16:O1
File List Model Library   MDC_TBD62003AFWG_LT01.lib
          Model Report   MDC_TBD62003AFWG_LT.pdf (this file)

Verified Simulator Version   LTspice version XVII
Note

References
The information which was used for modeling is as follow:

[Data Sheet]
● Date/Version   2015-07-24
● Product name   TBD62003AFWG
● Company name   Toshiba Corporation
● Characteristics   IleakVout[Temp],RonIout[Temp],IinVin[Temp],IinVin[Temp]2,
          IrVr[Temp],VfIf[Temp],SwVout[Tname]

Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Range			Unit
	Min.		Max.	
Temperature	-55	to	150	deg C

ARRAY

○ : Implemented
× : Not Implemented
— : Not applicable

Model Functions Table

Functions	RANK=1	
	RANK	Implemented
Ileak-Vout	1	○
Ron-Iout	1	○
Iin-Vin	1	○
Ir-Vr	1	○
Vf-If	1	○
Sw-Vout	1	○

Simulation results are following.
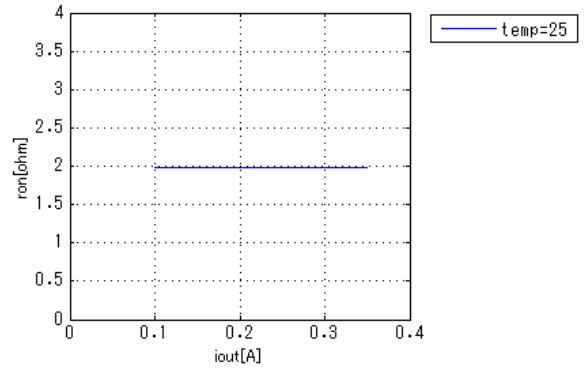Explanatory notes　　— : simulated

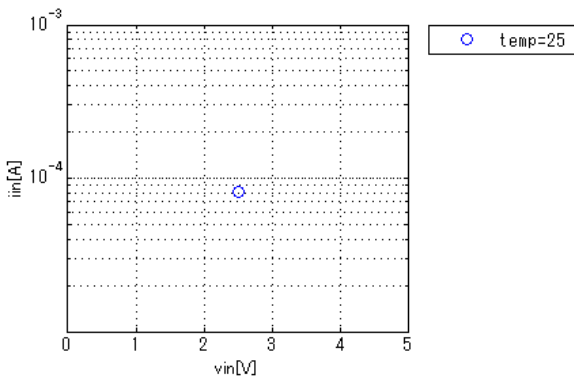### IleakVout[Temp]

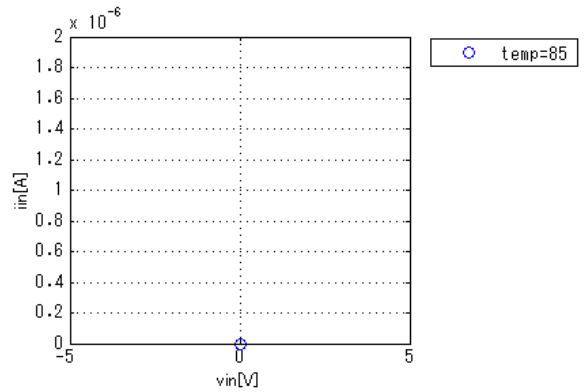vin = 0V, icom = 0A
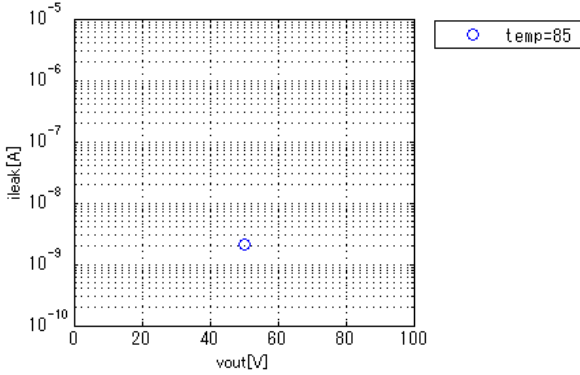
RonIout[Temp]

vin = 5V, icom = 0A

IinVin[Temp]

iout = 0A, icom = 0A

IinVin[Temp]2

iout = 0A, icom = 0A

IrVr[Temp]

iin = 0A, ignd = 0A
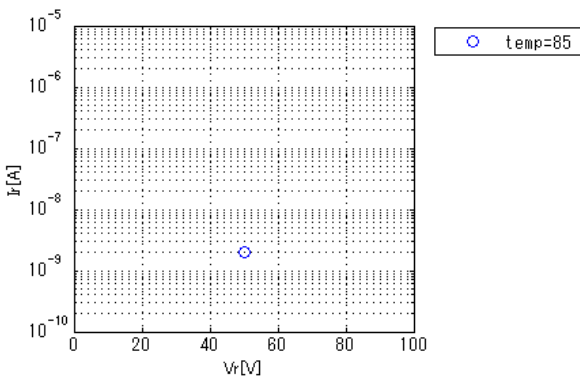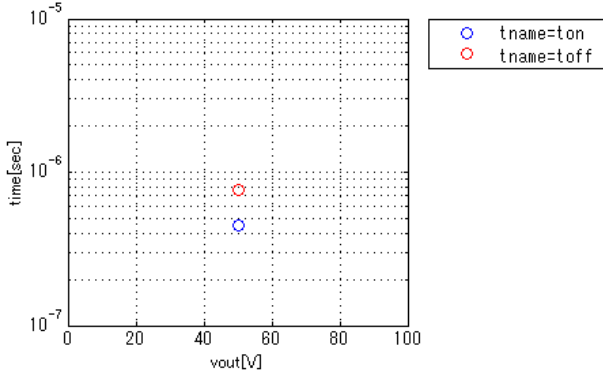

VfIf[Temp]

iin = 0A, ignd = 0A

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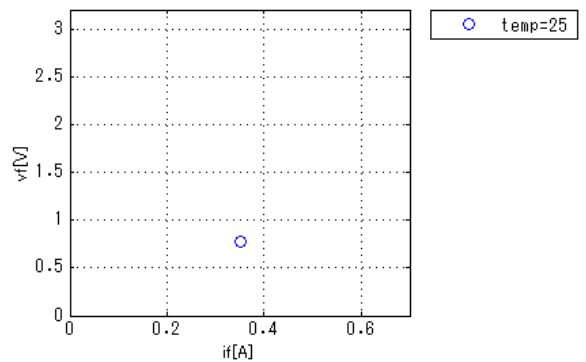
Simulation results are following.
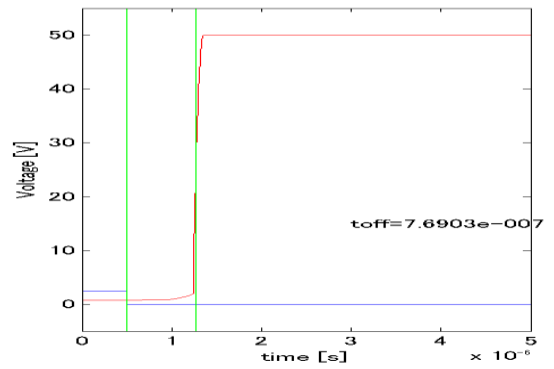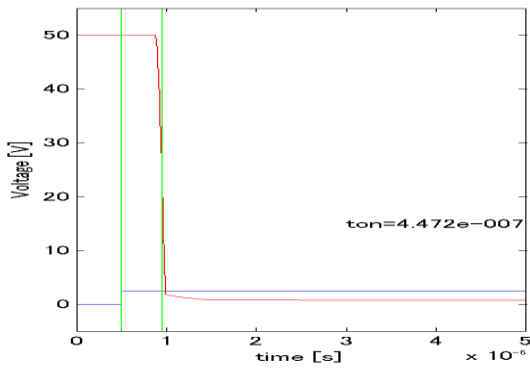Explanatory notes   ― : simulated

SwVout[Tname]

vin = 2.5V, RG = 5ohm, RL = 125ohm, icom = 0A, temp = 25degC

Switching Waveform (Blue : INPUT   Red : OUTPUT)

vin = 2.5V, vout = 50V, RG = 5ohm, RL = 125ohm, icom = 0A, temp = 25degC

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